



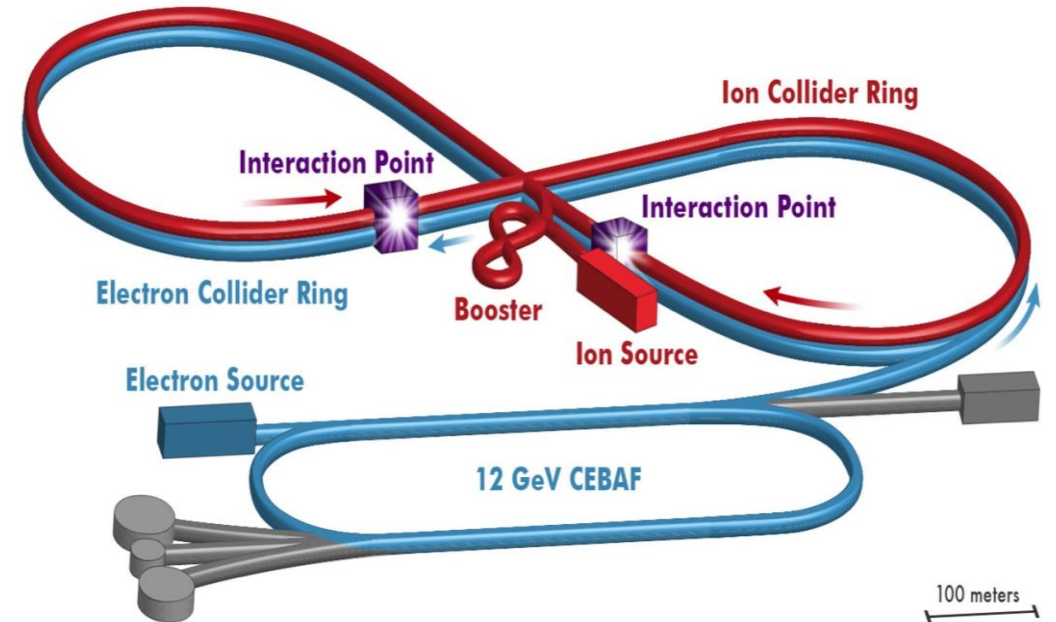
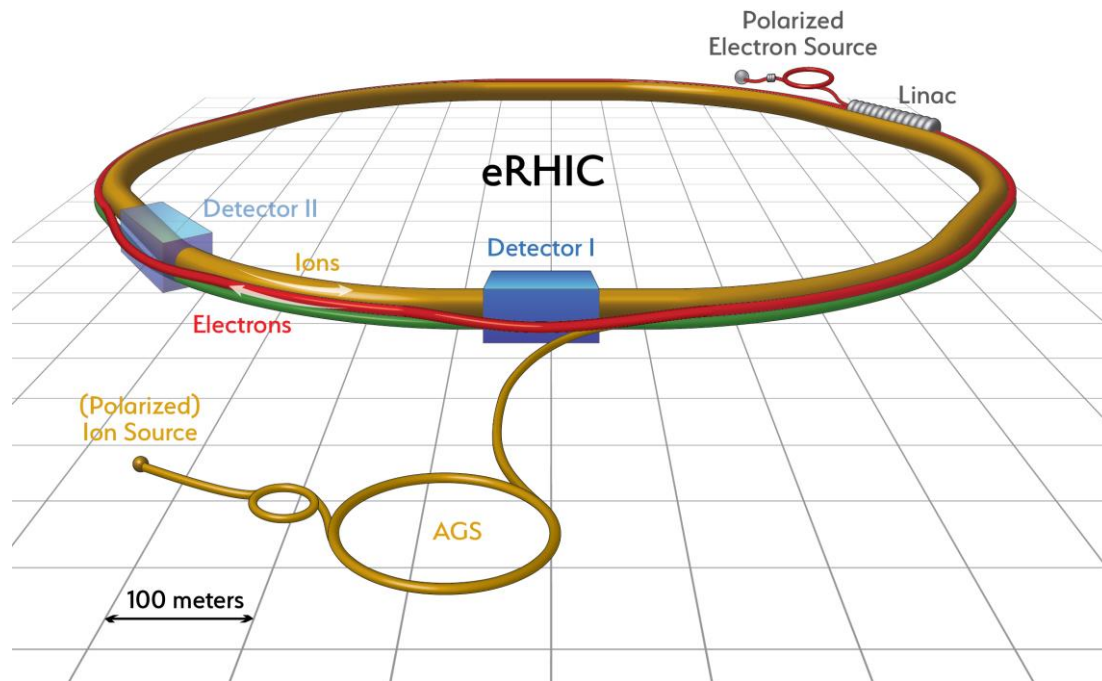
# Study of feasibility of electronics and detectors to determine bunch by bunch beam properties for the EIC ring-ring designs

Nicola Minafra  
University of Kansas

C. Royon, M. J. Murray  
A. Camsonne

KU  
JLAB

# Electron Ion Collider designs



## Lower luminosity

560 MHz RF  
330 bunches  
33 ns between bunches  
Electron current up to 1.2 A  
Ion current up to 0.46 A

## High luminosity

560 MHz RF  
1320 bunches  
10 ns between bunches  
Electron current up to 2.4 A  
Ion current up to 0.92 A

## Low and Medium energy

476 MHz RF  
1540x2 bunches  
2.1 ns between bunches  
Electron current up to 2.8 A  
Ion current up to 0.75 A

## High energy

476 or 119 MHz RF  
385 x 2 bunches  
8.4 ns between bunches  
Electron current up to 0.75 A  
Ion current up to 0.71 A

Need detector response from 33 ns up to 2.1 ns to measure cleanly bunch by bunch

# Bunch by bunch properties : example Compton polarimeter



eRHIC Linac Ring :

- several sources with different polarization used, need to separate 10 MHz beam structure

eRHIC Ring Ring – JLEIC

Energy (GeV)	Current (A)	1 pass laser (10W)	FP cavity (10 kW)
		Expected rate (MHz)	Expected rate (MHz)
3	3	26.8	3100
5	3	16.4	1880
10	0.72	1.8	210

Only considering Compton cross-section: no background

[EIC Detector R&D Progress Report June 2016](#)

# Problem: detect MIPs with bunch separation down to 2 ns



- Can bunches be temporally separated for all configurations (down to 2 ns)?
- Is it possible to uniquely associate a detected particle with the correct bunch crossing?
- Are there any scaling issues to go from 1 channel to 200 channels

( needed for electron polarimetry for example )

## **Detector with a signal faster than ~2 ns:**

1 particle every bunch crossing per channel

(expected rate for 10 kW laser power >3 GHz per 5 cm<sup>2</sup>)

- Sensor, amplifier, digitizer, DAQ to be designed

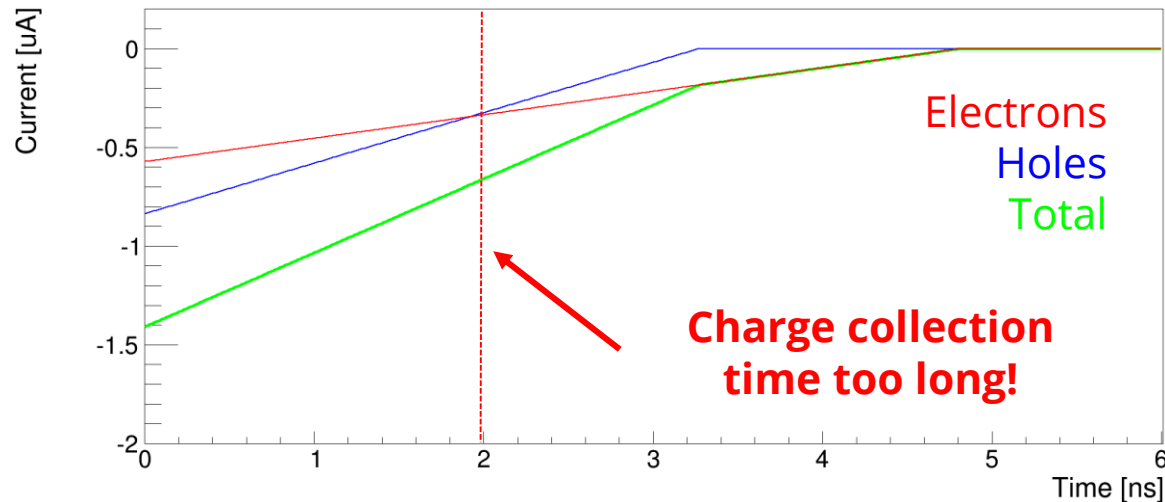
## **Detector with a time precision better than ~2 ns:**

- Increased segmentation
- Less challenging detector requirements, but more channels
- Digitizer, DAQ to be designed

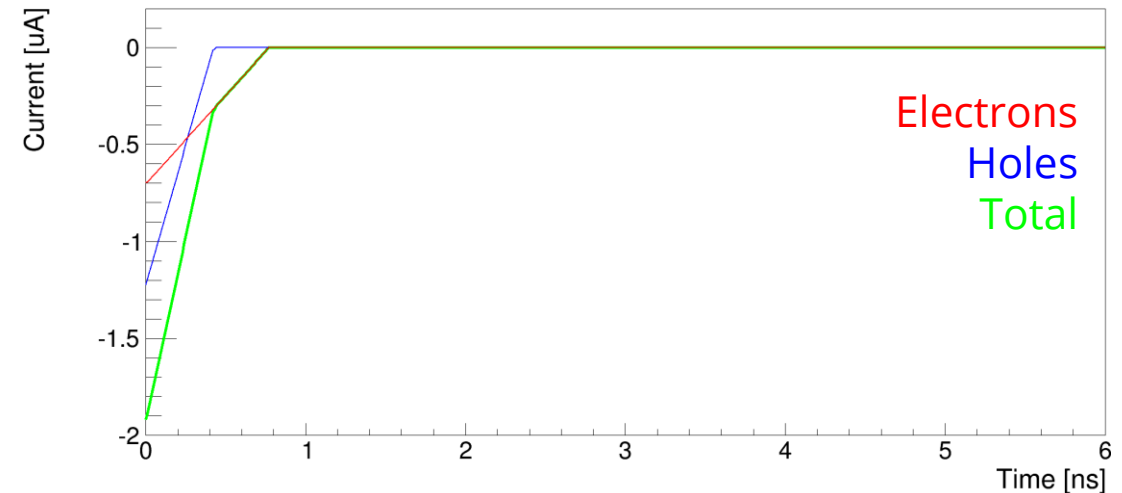
# Is it possible to design a MIP detector with a signal shorter than 2 ns?



Diamond sensors are among the fastest available



500  $\mu\text{m}$  scCVD diamond @ 800V



80  $\mu\text{m}$  scCVD diamond @ 500V

The collection time  $t_c$  depends on the thickness  $d$   $t_c \sim d/v_s$

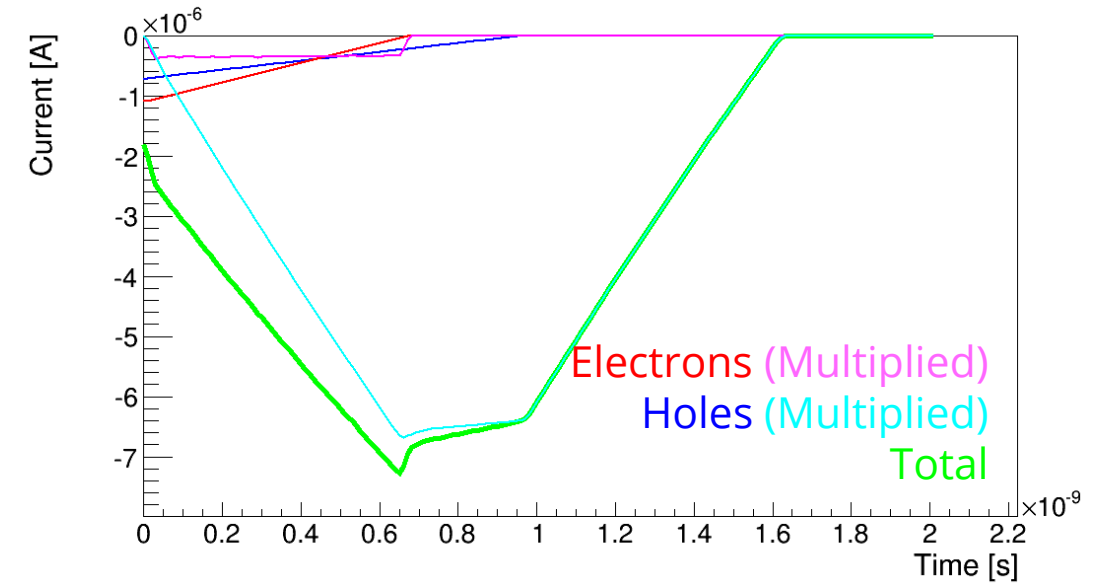
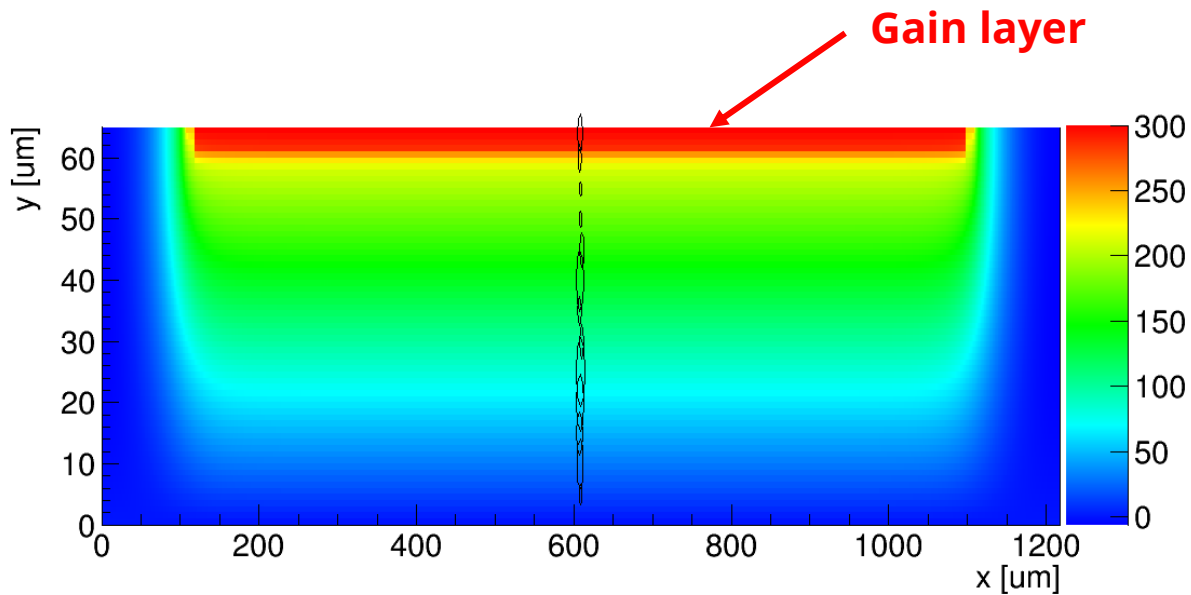
NOTE: the collected charge  $Q_c = \int i(t) dt$  also depends on the thickness  $d$   $Q_c \sim d$

However, the peak current mainly depends on the carriers' velocities, i.e. electric field  $|i_{MAX}| \sim Q_c/t_c$

# Is it possible to design a MIP detector with a signal shorter than 2 ns?



Ultra Fast Silicon Detectors: as fast as diamond, but with a gain layer!



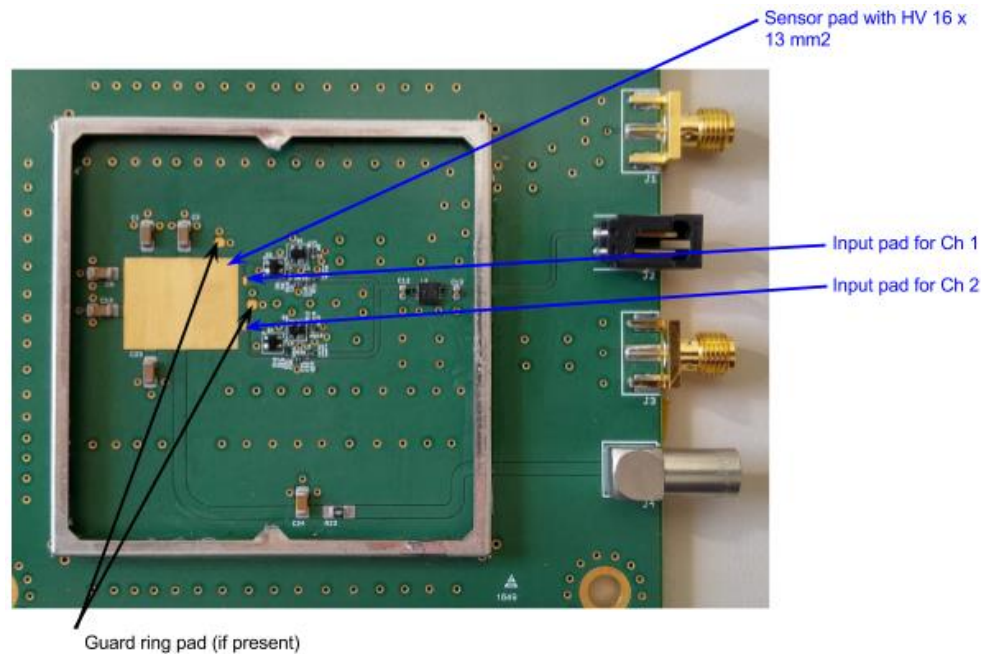
UFSD: 50 μm LGAD

Fast collection time (50 μm thick) and larger signals, thanks to the gain layer

# Electronics for very fast detectors



A two channels board was designed and manufactured for the characterization of different solid state detectors.

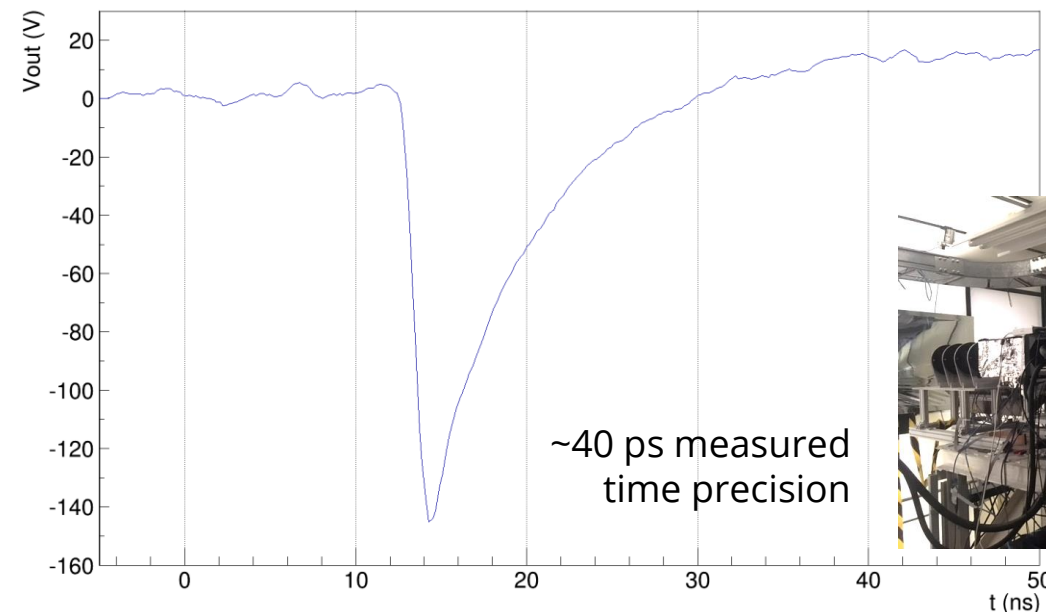


Sensors up to  $16 \times 13 \text{ mm}^2$  can be glued and bonded.

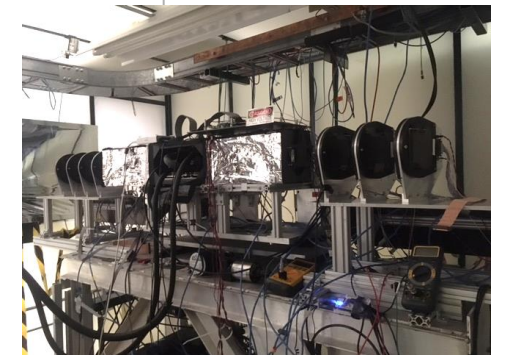
The components can be easily adapted to accommodate:

- Diamond sensors:  $\sim 1 \text{ nA}$  bias current, both polarities, small signal
- Silicon sensors:  $\sim 100 \text{ nA}$  bias current, small signal
- UFSD  $\sim 100 \text{ nA}$  bias current,  $\sim$  larger signal
- SiPM:  $\sim 5 \text{ uA}$  bias current, large signal

The board was optimized to achieve a good time precision with different sensors, however it can be modified to have an output signal shorter (but less precise)



$3 \times 3 \text{ mm}^2$  UFSD  
MIP beam test @  
Fermilab

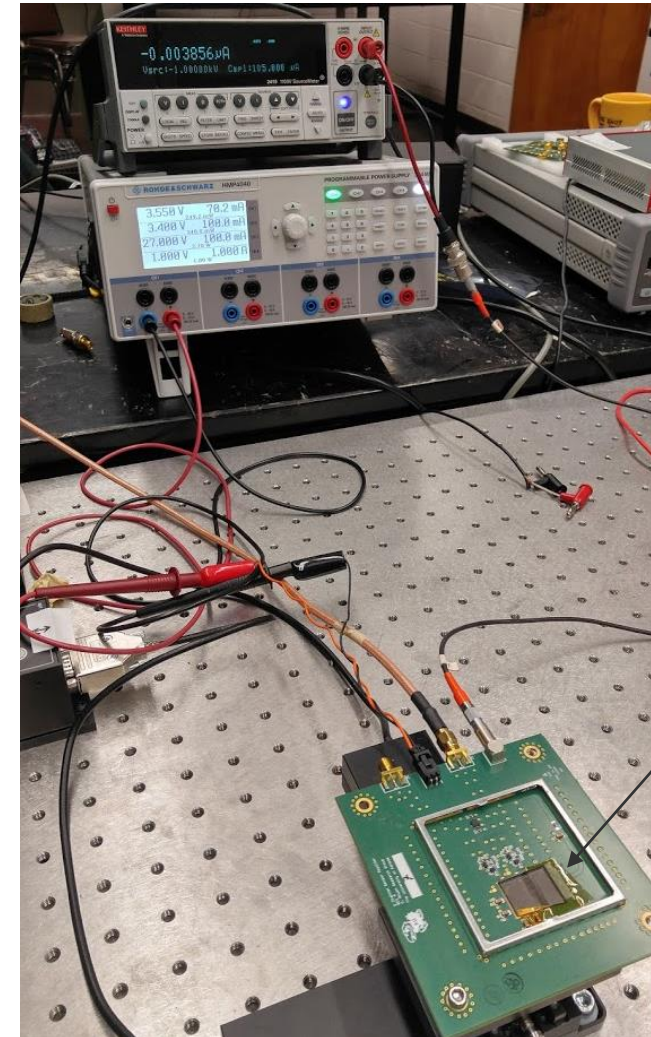
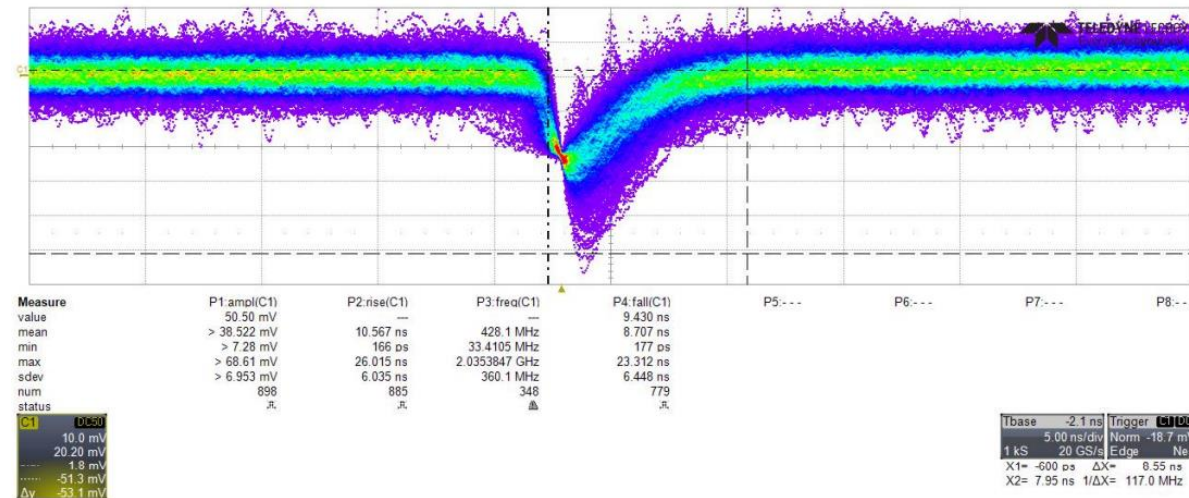
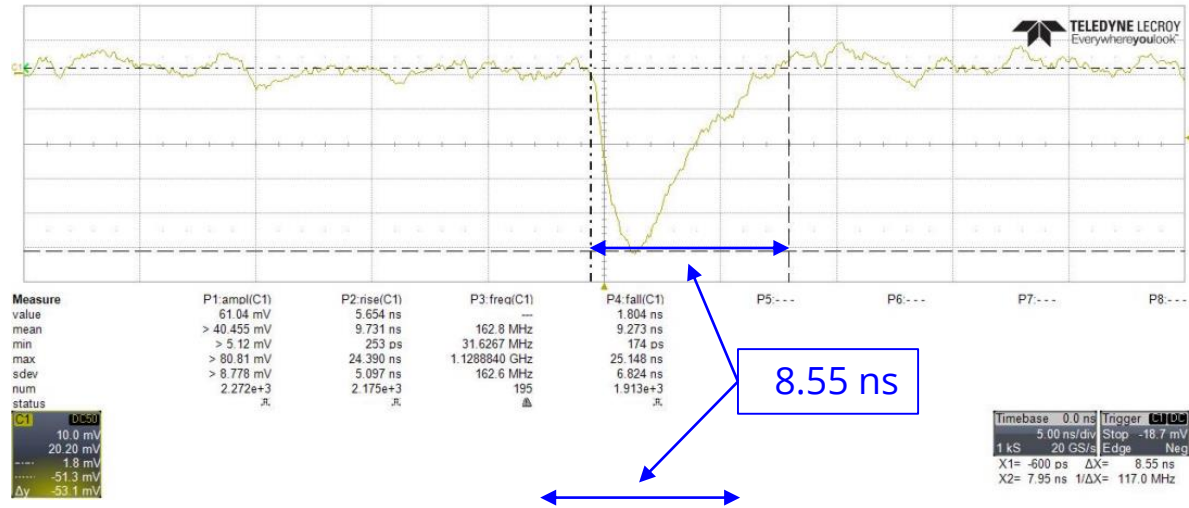




# Electronics for very fast detectors



This board was also used to test the performance of a diamond sensor using a  $\text{Sr}^{90}$   $\beta^-$  source.

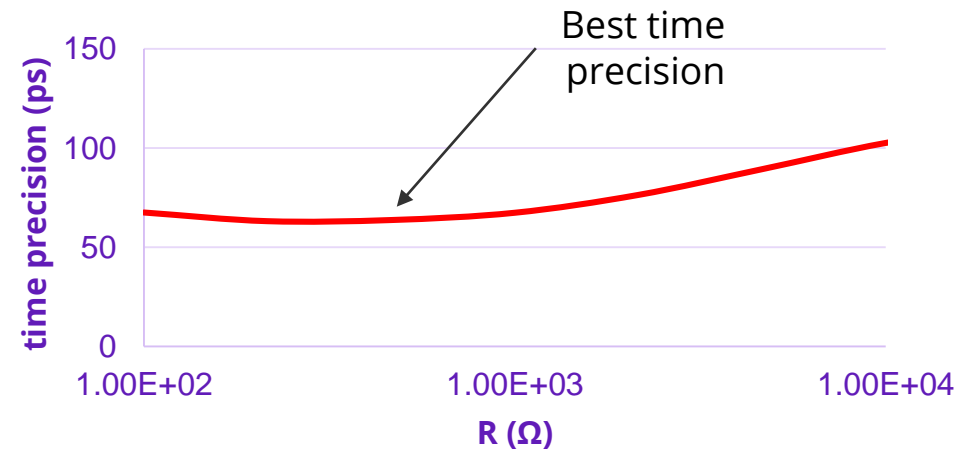
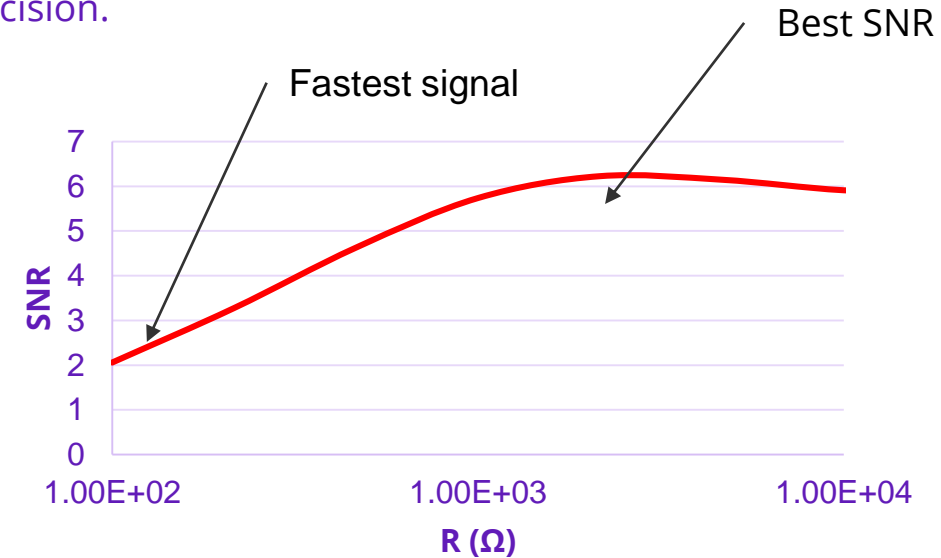
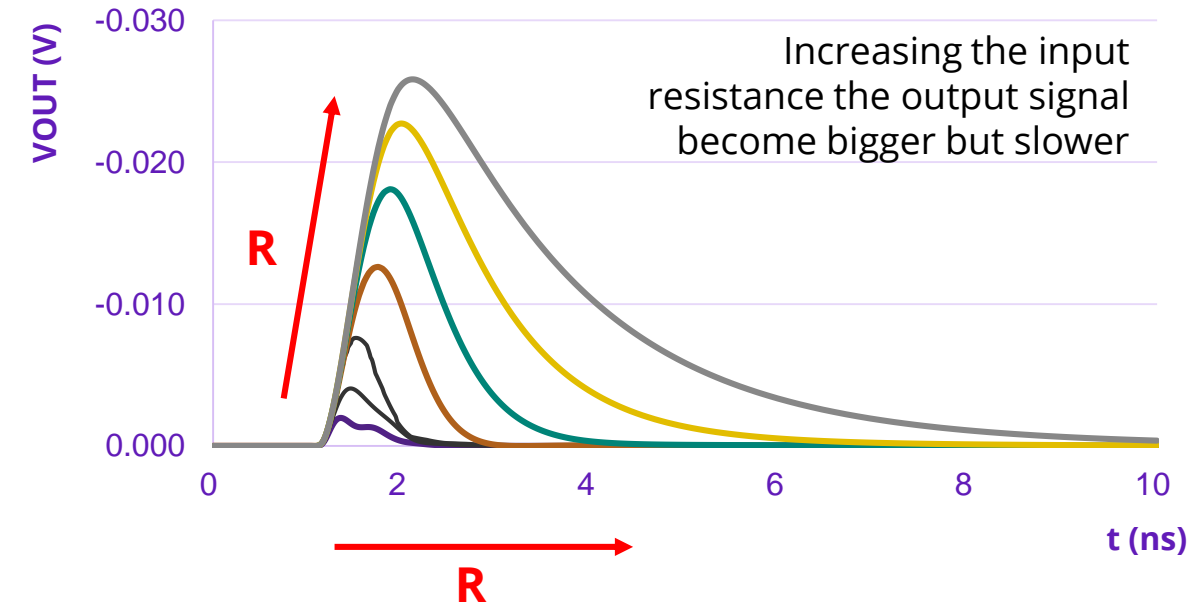
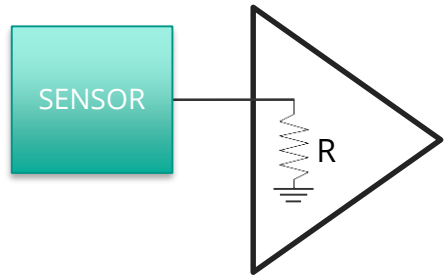




# Is it possible to design a MIP detector with a signal shorter than 2 ns (modifying the KU board)?



The amplifier can be modified to have a faster signal but worse time precision.

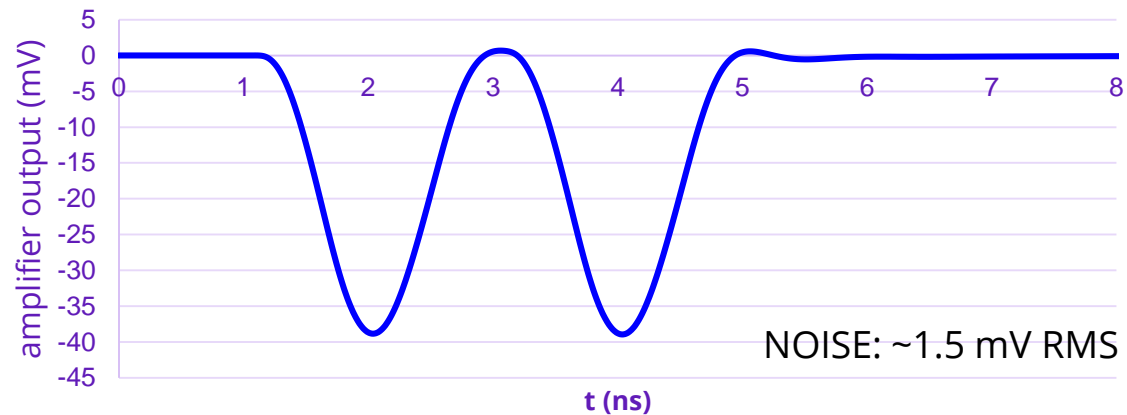
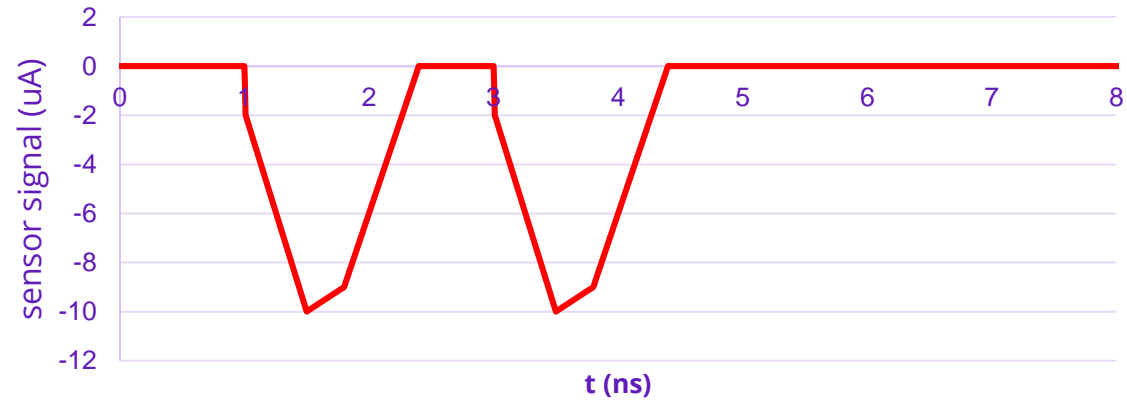


# Is it possible to design a MIP detector with a signal shorter than 2 ns?



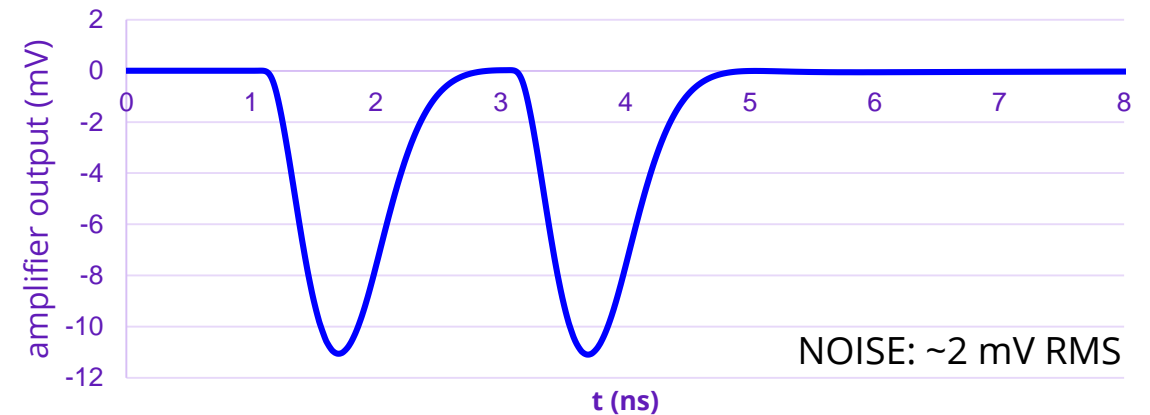
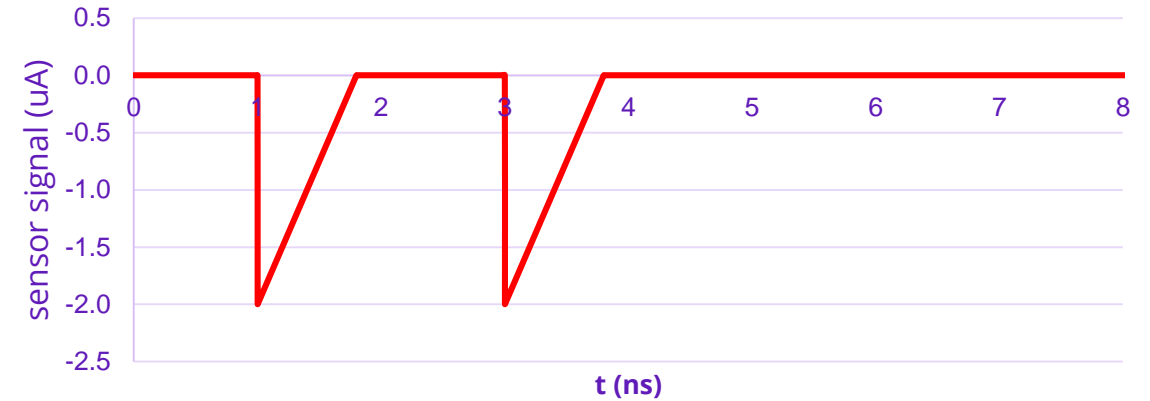
Simulated results:

UFSD



SNR ~ 25

80  $\mu$ m scCVD diamond sensor

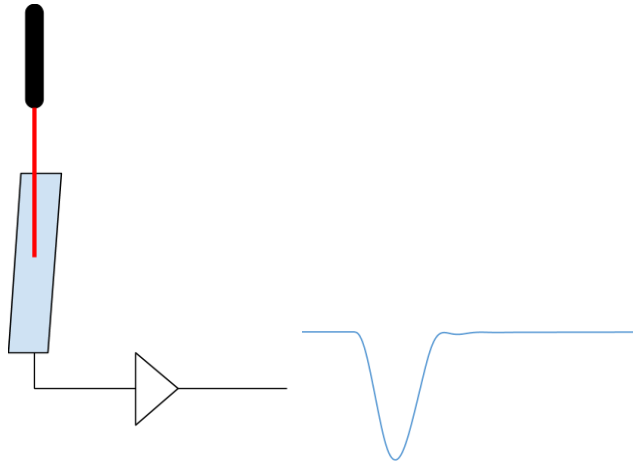


SNR ~ 5

# Laser tests for silicon sensors



To test the high rate capabilities of the detector a laser pulse can be used

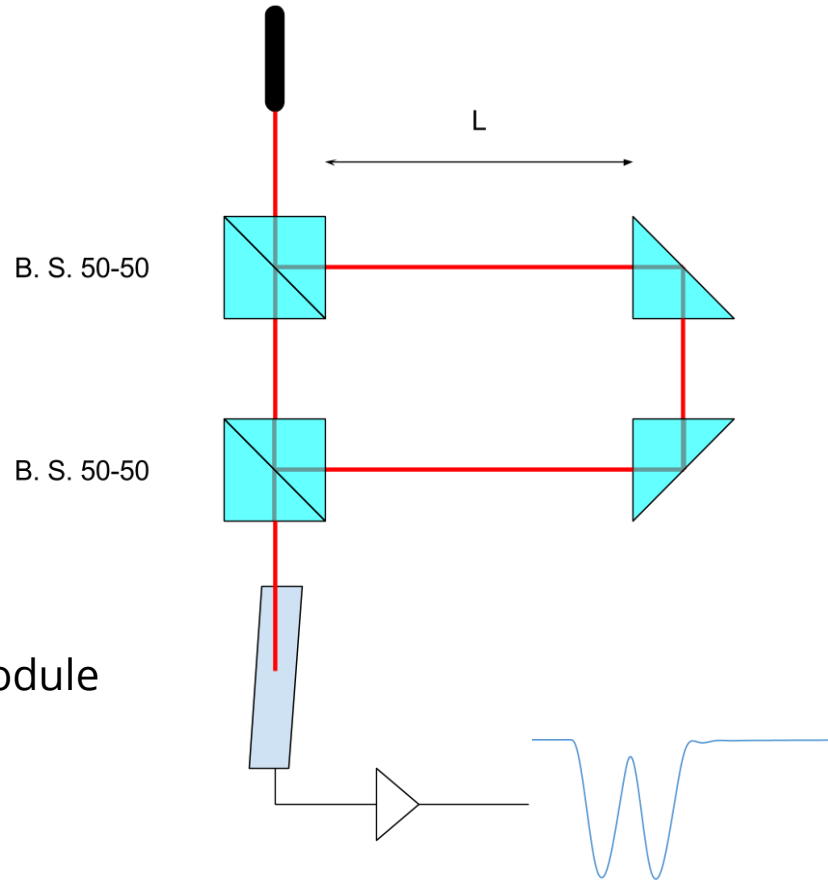


Infrared laser with fast pulses:

PILAS Gain-switched laser diode module

1060 nm, FWHM < 50 ps

Repetition rate < 10 MHz



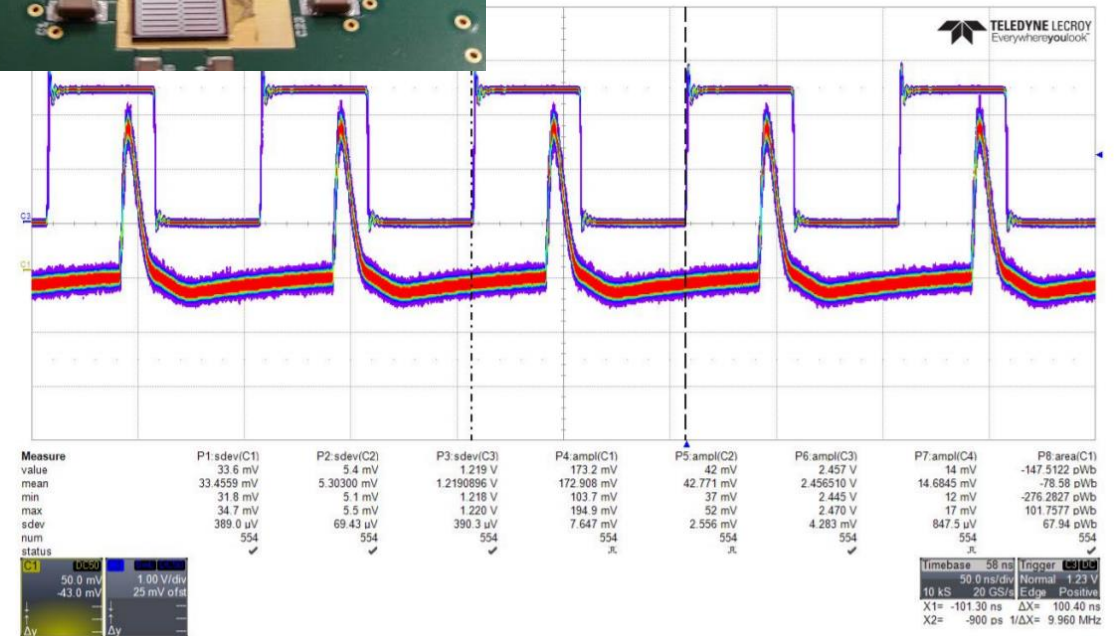
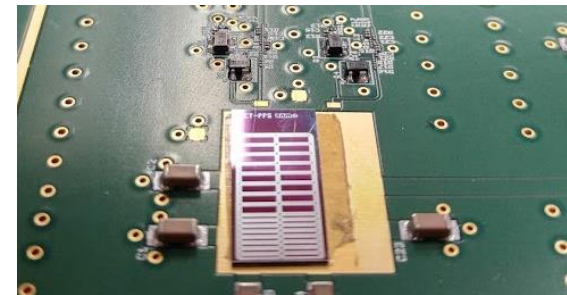
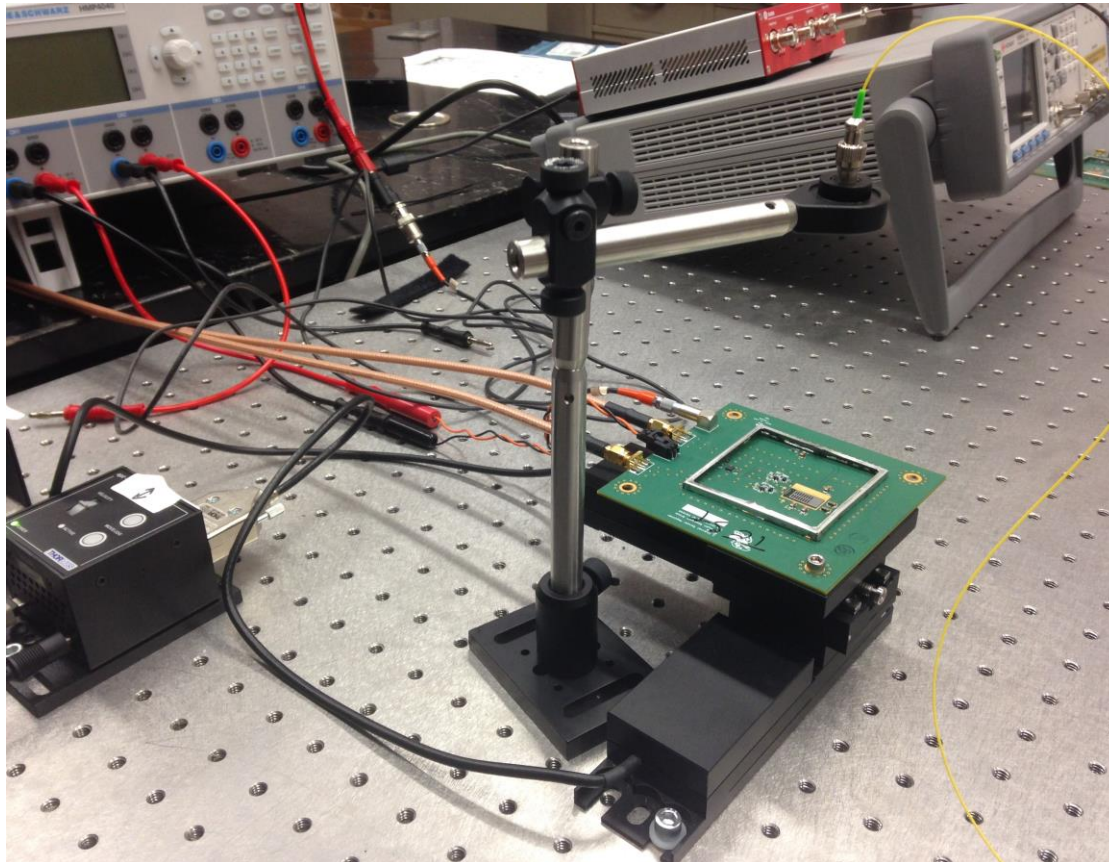
Using a chain of beam splitter it is possible to introduce several delays on the light path and produce two pulses with a separation of:

$$\Delta t \sim 2 L / c$$

# KU Capabilities

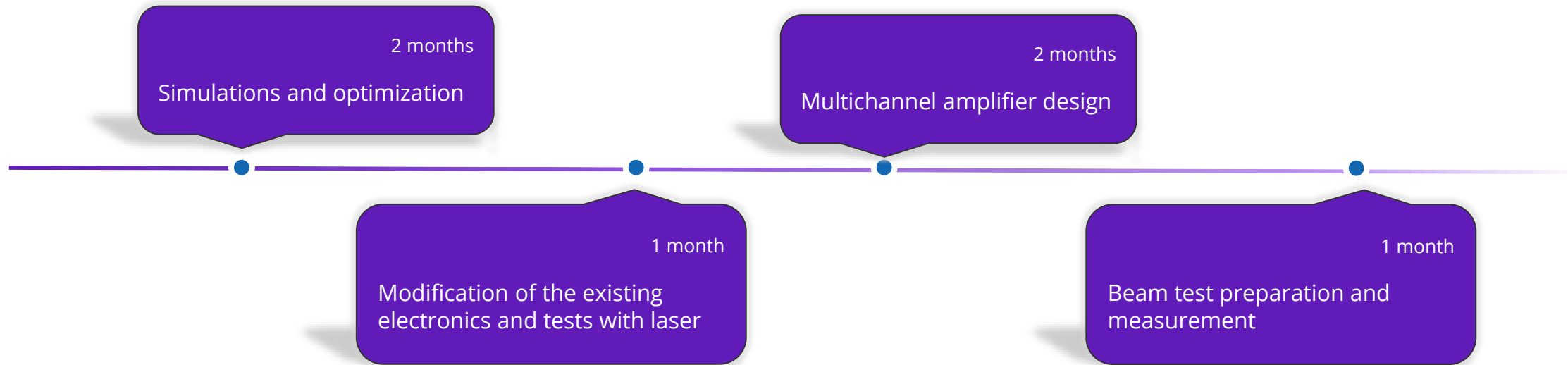


KU has already a test stand with a picosecond laser, but the maximum rate is limited to 10 MHz



1080 nm picosecond laser, 50 ps wide pulses with peak power > 100 mW set at 10 cm away from the sensor board  
The support can be moved XY with micrometric accuracy

# Timeline



# Budget request



Task		Amount direct (k\$)	Amount with Overhead (k\$)	Cumulative (k\$)
Simulation	3 months postdoc	18	27.81	27.81
Amplifier modification	Production cost	5	7.725	35.535
Optimized amplifier design	3 months postdoc	18	27.81	63.345
Detector	Production cost	2.5	3.86	67.20
Multichannel amplifier	Production cost	20	30.9	98.1
Total		63.5	<b>98.1</b>	

Will participate if approved: 1 el. engineer (undergrad), 1 physicist (graduate) (funded by KU)



# Budget scenario



Budget	Amount (k\$)	Deliverables
Full	98.1	Optimized electronics and detector, beam test with multichannel amplifier
-20 %	82.8	Optimized electronics design, laser test with one channel modified amplifier
-40 %	62.1	Simulation and optimized amplifier design, laser or $\text{Sr}^{90}$ test

# Summary



Preliminary simulations show that short pulses can be generated with a reasonable signal to noise ratio

- Simulate different sensors, different size (thickness, capacitance, ... )
- Modify existing amplifier and test with existing detector
- Design multichannel optimized amplifier
- Built multichannel amplifier
- Laser tests for high rate
- MIP (efficiency) test on particle beam



# Study of feasibility of electronics and detectors to determine bunch by bunch beam properties for the EIC ring-ring designs

Nicola Minafra  
University of Kansas

C. Royon, M. J. Murray  
A. Camsonne

KU  
JLAB

# Bunch by bunch properties : example Compton polarimeter



eRHIC Linac Ring :

- several sources with different polarization used, need to separate 10 MHz beam structure

eRHIC Ring Ring – JLEIC

Energy	Current	1 pass laser (10 W)		FP cavity (1 kW)	
(GeV)	(A)	Rate (MHz)	Time (1%)	Rate (MHz)	Time (1%)
3 GeV	3	26.8	161 ms	310	14 ms
5 GeV	3	16.4	106 ms	188	9 ms
10 GeV	0.72	1.8	312 ms	21	27 ms

Only considering Compton cross-section: no background

## Example polarization lifetime JLEIC



Energy (GeV)	$\tau_{inj}$ (min)	$\tau_{opt\_meas}$ (min)	$(P_{ave}/P_i)_{max}^*$
3	12	160	0.94
5	8	60	0.88
7	4	20	0.85
9	0.8	6	0.89
10	0.5	2.5	0.86

Polarization measurement of the order of second desired for short measurement at different point of the beam life

If same number of bunches and bunch-by-bunch polarization is needed, measurement duration has to be multiplied by number of bunches from 700 to 3300: high laser power cavity is needed

# Main Parameters eRHIC ring-ring for Maximum Luminosity

		No Hadron Cooling		Strong Hadron Cooling	
Parameter	Units	Protons	Electrons	Protons	Electrons
Center of Mass Energy	GeV	100		100	
Beam Energy	GeV	275	10	275	10
Particles/bunch	$10^{10}$	11.6	31	5.6	15.1
Beam Current	mA	456	1253	920	2480
Number of Bunches		330		1320	
Hor. Emittance	nm	17.6	24.4	8.3	24.4
Vertical Emittance	nm	6.76	3.5	3.1	1.7
$\beta_x^*$	cm	94	62	47	16
$\beta_y^*$	cm	4.2	7.3	2.1	3.7
$\sigma_x'^*$	mrاد	0.137	0.2	0.13	0.39
$\sigma_y'^*$	mrاد	0.401	0.22	0.38	0.21
Beam-Beam $\xi_x$		0.014	0.084	0.012	0.047
Beam-Beam $\xi_y$		0.0048	0.075	0.0043	0.084
$\tau_{IBS}$ long/hor	hours	10/8	-	4.4/2.0	-
Synchr. Rad Power	MW	-	6.5	-	10
Bunch Length	cm	7	0.3	3.5	0.3
Luminosity	$10^{34} \text{ cm}^{-2} \text{ s}^{-1}$	0.29		1.21	

$E_p = 275 \text{ GeV}$ ,  $E_e = 10 \text{ GeV}$

New eRHIC ring ring design : beam interaction frequency going from initial RHIC 10 MHz to 30 MHz with 330 bunches and 100 MHz with 1320 bunches in a 3.8 km ring



# JLEIC Baseline New Parameters

CM energy	GeV	21.9 (low)		44.7 (medium)		63.3 (high)	
		p	e	p	e	p	e
Beam energy	GeV	40	3	100	5	100	10
Collision frequency	MHz	476		476		476/4=119	
Particles per bunch	$10^{10}$	0.98	3.7	0.98	3.7	3.9	3.7
Beam current	A	0.75	2.8	0.75	2.8	0.75	0.71
Polarization	%	80	80	80	80	80	75
Bunch length, RMS	cm	3	1	1	1	2.2	1
Norm. emitt., hor./vert.	$\mu\text{m}$	0.3/0.3	24/24	0.5/0.1	54/10.8	0.9/0.18	432/86.4
Horizontal & vertical $\beta^*$	cm	8/8	13.5/13.5	6/1.2	5.1/1	10.5/2.1	4/0.8
Vert. beam-beam param.		0.015	0.092	0.015	0.068	0.008	0.034
Laslett tune-shift		0.06	$7 \times 10^{-4}$	0.055	$6 \times 10^{-4}$	0.056	$7 \times 10^{-5}$
Detector space, up/down	m	3.6/7	3.2/3	3.6/7	3.2/3	3.6/7	3.2/3
Hourglass(HG) reduction		1		0.87		0.75	
Luminosity/IP, w/HG, $10^{33}$	$\text{cm}^{-2}\text{s}^{-1}$	2.5		21.4		5.9	

Ring circumference : 2.4 km

Max number of bunches :3416

Number of bunches : 1540 \* 2 two macrobunches

with 2.1 ns spacing between electron bunches